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Attorney Docket No.: I433.166.101/13642

**RECORDATION FORM COVER SHEET
PATENTS ONLY**

To the Commissioner of Patents:

Please record the attached original signed documents or copy thereof.

1. Name of conveying partie(ies):

Johann Rieger
Stefan Lipp
Hans Peter Zeindl
Thomas Detzel
Hubert Maier

2. Name and address of receiving party(ies)

Infineon Technologies AG
St.-Martin-Str. 53
81669 Munich
GERMANY

Additional name(s) of conveying party(ies)
attached? **No**

Additional name(s) and address(es)
attached? **No**

3. Nature of conveyance:

☒ Assignment ☐ Merger

☐ Other: _____

Execution Date(s): 09/20/05; 08/07/05; 07/20/05; 07/07/05; 07/11/05

4. Application number(s) or patent number(s):

A. Patent Application No(s).

B. Patent No(s).

11/138,984

Additional number(s) attached? **No**

5. Name and address of party to whom correspondence concerning document should be mailed:

Customer No. 025281
Steven E. Dicke
Dicke, Billig & Czaja, PLLC
Suite 2250
100 South Fifth Street
Minneapolis, Minnesota 55402

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. 3.41): \$40.00

☐ Enclosed

☒ Authorized to be charged to Deposit Account No. 500471

8. Deposit Account No. 500471

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9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Name of Person Signing: Paul P. Kempf

Signature: 

Date: _____

Total number of pages comprising cover sheet: 6

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PATENT
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INFINEON REF NO. 13642
O.C. REF NO. I433.166.101

ASSIGNMENT

For good and valuable consideration, I, Johann Rieger, a citizen of Germany, residing at Heckbergweg 6, 93077 Bad Abbach, Germany; Stefan Lipp, a citizen of Germany, residing at Badstr. 74, 92318 Neumarkt, Germany; Hans Peter Zeindl, a citizen of Germany, residing at Hohenweg 4, 84032 Altdorf, Germany; Thomas Detzel, a citizen of Germany, residing at Anzengruberstr. 9, 9500 Villach, Austria; and Hubert Maier, a citizen of Germany, residing at Herbert-Strutz-Str. 5, 9500 Villach, Austria, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on May 26, 2005US. Serial No. 11/138,984.entitled: METHOD FOR FORMING INTEGRATED SEMICONDUCTOR CIRCUIT
ARRANGEMENT

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

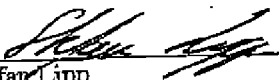
Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____

NAME: Johann Rieger

DATE: _____

20.9.05

SIGNATURE:  DATE: 07/08/05
NAME: Stefan Lipp

SIGNATURE: _____ DATE: _____
NAME: Hans Peter Zeindl

SIGNATURE: _____ DATE: _____
NAME: Thomas Detzel

SIGNATURE: _____ DATE: _____
NAME: Hubert Maier

SIGNATURE: _____ DATE: _____
NAME: Stefan Lipp

SIGNATURE: Dr. Hans Peter Zeindl DATE: 2005-07-20
NAME: Hans Peter Zeindl

SIGNATURE: _____ DATE: _____
NAME: Thomas Detzel

SIGNATURE: _____ DATE: _____
NAME: Hubert Maier

SIGNATURE: _____ DATE: _____
NAME: Stefan Lipp

SIGNATURE: _____ DATE: _____
NAME: Hans Peter Zeindl

SIGNATURE: Thomas Detzel DATE: 7.7.05
NAME: Thomas Detzel

SIGNATURE: _____ DATE: _____
NAME: Hubert Maier

SIGNATURE: _____ DATE: _____
NAME: Stefan Lipp

SIGNATURE: _____ DATE: _____
NAME: Hans Peter Zeindl

SIGNATURE: _____ DATE: _____
NAME: Thomas Detzel

SIGNATURE:  DATE: 11.07.2005
NAME: Hubert Maier